

FEATURES:

- High Density Power Module
- 600mA Output Current
- Input Voltage Range from 2.7V to 5.5V
- Fixed Output Voltage
- 100% Maximum Duty Cycle with Low Dropout
- Enable Function
- Automatic Power Saving/PWM Mode
- Protections (UVLO, OCP: Non-latching)
- Internal Soft Start
- Compact Size: 2.5mm*2.0mm*1.05mm
- Pb-free for RoHS compliant
- MSL 3, 260C Reflow

APPLICATIONS:

- Single Li-Ion Battery-Powered Equipment
- LDOs Replacement
- Cell phone / PDAs / Palmtops

GENERAL DESCRIPTION:

The MMN3C1ER6-MB power module series is non-isolated dc-dc converters that can deliver up to 600mA of output current. The PWM switching regulator, high frequency power inductor are integrated in one hybrid package. It needs input and output capacitor only and no additional feedback circuit.

The MMN3C1ER6-MB power module series has automatic operation with PWM mode and power saving mode according to loading. Other features include remote enable function, internal soft-start, non-latching over current protection, and input under voltage locked-out capability.

The low profile and compact size package (2.5mm × 2.0mm × 1.05mm) is suitable for automated assembly by standard surface mount equipment. The MMN3C1ER6-MB power module series is Pb-free and RoHS compliance.

TYPICAL APPLICATION CIRCUIT & PACKAGE:

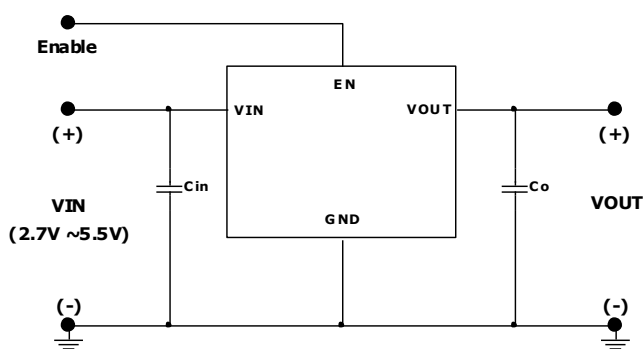


FIGURE 1 TYPICAL APPLICATION CIRCUIT

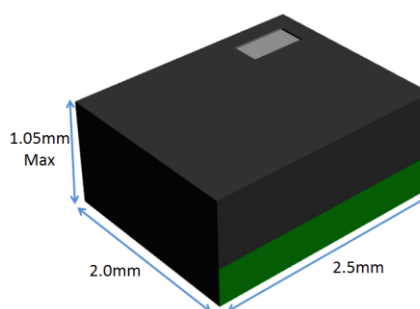
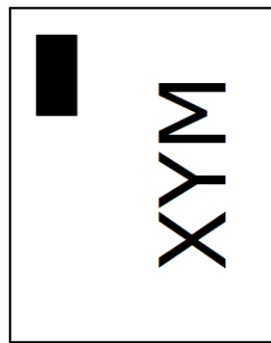


FIGURE 2 HIGH DENSITY LOW PROFILE
uPOL MODULE

ORDERING INFORMATION:

CAUTION: These devices have limited built-in ESD protection. The leads should be shorted together or the devices placed in conductive foam during the storage or handling to prevent electrostatic damage to internal circuit.

PART NUMBER	OUTPUT VOLTAGE	MARKING (Code: X)	ORDERING	QUANTITY
MMN3C1ER6-MB	1.5V	E	MMN3C1ER6-MB	2000

PACKAGE MARKING INFORMATION:**TOP VIEW****Code:**

- **X – Output Voltage Specific**
- **Y – Year**
- **M - Month**

ELECTRICAL SPECIFICATIONS:

CAUTION: Do not operate at or near absolute maximum rating listed for extended periods of time. This stress may adversely impact product reliability and result in failures outside of warranty.

Parameter	Description	Min.	Typ.	Max.	Unit
■ Absolute Maximum Ratings					
VIN to GND		-	-	+6.0	V
VOUT to GND		-	-	+6.0	V
EN to GND		-	-	VIN+0.3	V
Tc	Case Temperature of Inductor	-	-	+110	°C
Tj	Junction Temperature	-40	-	+150	°C
Tstg	Storage Temperature	-40	-	+125	°C
ESD Rating	Human Body Model (HBM)	-	-	2k	V
	Machine Model (MM)	-	-	200	V
	Charge Device Model (CDM)	-	-	1k	V
■ Recommendation Operating Ratings					
VIN	Input Supply Voltage	+2.7	-	+5.5	V
Ta	Ambient Temperature	-40	-	+85	°C
■ Thermal Information					
Rth(jchoke-a)	Thermal resistance from junction to ambient. (Note 1)	-	65	-	°C/W

NOTES:

1. Rth(jchoke-a) is measured with the component mounted on an effective thermal conductivity test board on 0 LFM condition. The test board size is 30mm×30mm×1.6mm with 2 layers. The test condition is compliant with JEDEC EIJ/JESD 51 Standards.

ELECTRICAL SPECIFICATIONS: (Cont.)

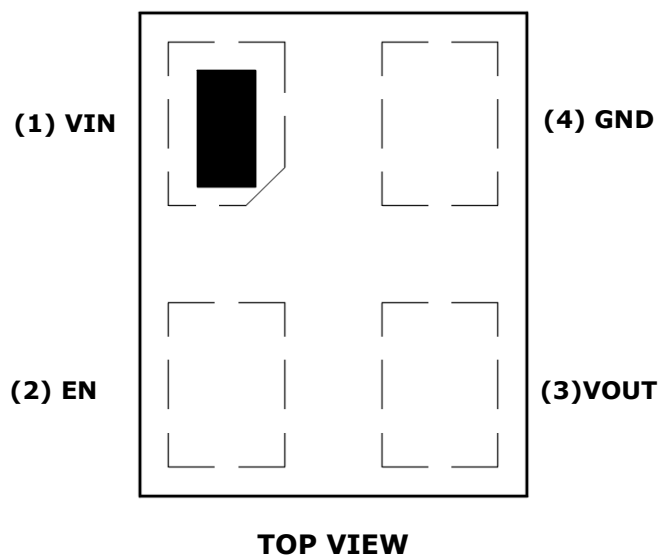
Conditions: $T_A = 25\text{ }^{\circ}\text{C}$, $V_{in} = 3.3\text{V}$, $C_{in} = 4.7\mu\text{F}/6.3\text{V}/0603$, $C_{out} = 10\mu\text{F}/6.3\text{V}/0402$ unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
■ Input Characteristics						
I _{SD(IN)}	Input shutdown current	Vin = 3.3V, Vin connected EN by 100K ohm EN = GND	-		-	uA
		Vout=1.5 V		50		
I _{Q(IN)}	Input supply bias current	Vin = 3.3V, Iout = 0A EN = VIN	-			uA
		Vout=1.5 V		23		
I _{S(IN)}	Input supply current	Vin = 3.3V, EN = VIN Iout = 5mA				mA
		Vout=1.5 V		2.9		
		Vin = 3.3V, EN = VIN Iout = 100mA				mA
		Vout=1.5 V		56		
		Vin = 3.3V, EN = VIN Iout = 600mA				mA
		Vout=1.5 V		360		
■ Output Characteristics						
I _{OUT(DC)}	Output continuous current range	Vin=3.3V, Vout=1.5V	0	-	600	mA
V _{O(SET)}	Ouput Voltage Set Point	Vin=3.3V	-3.0		+3.0	% V _{O(SET)}
ΔV _{OUT} / ΔV _{IN}	Line regulation accuracy	Vin = 3.3V to 5V Iout = 0A Iout = 600mA	-	0.1	0.2	% V _{O(SET)}
ΔV _{OUT} / ΔI _{OUT}	Load regulation accuracy	Iout = 0A to 600mA Vin = 3.3V,	-	0.5	1.0	% V _{O(SET)}

ELECTRICAL SPECIFICATIONS: (Cont.)

Conditions: $T_A = 25\text{ }^{\circ}\text{C}$, $V_{in} = 3.3\text{V}$, $C_{in} = 4.7\mu\text{F}/6.3\text{V}/0603$, $C_{out} = 10\mu\text{F}/6.3\text{V}/0603$ unless otherwise specified.

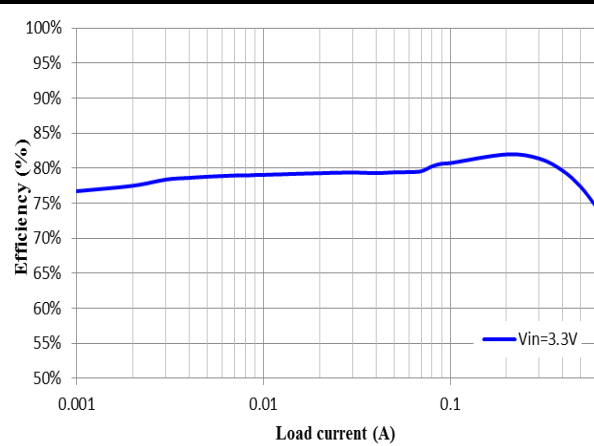
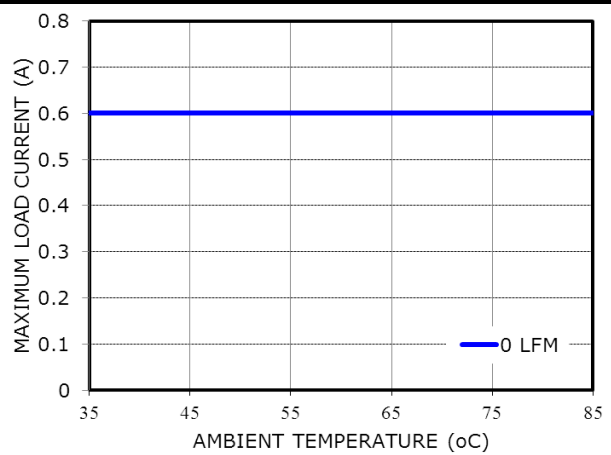
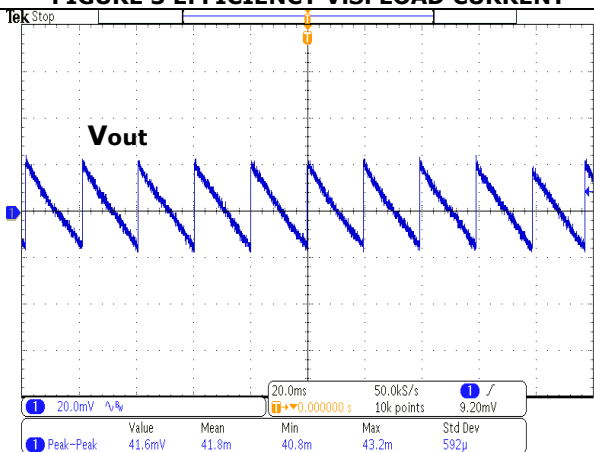
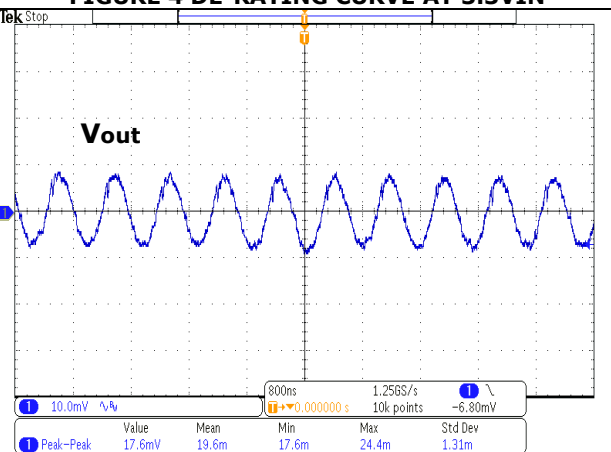
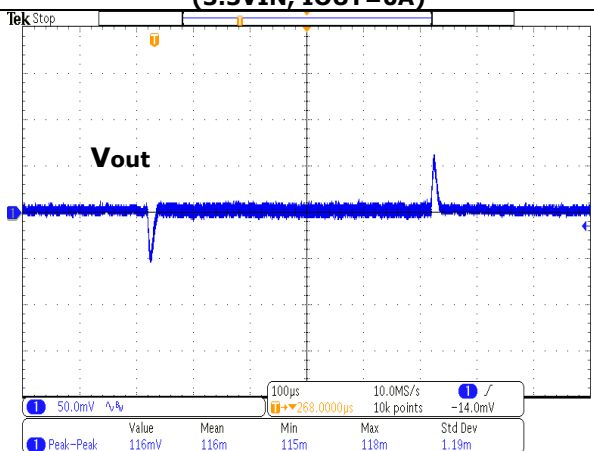
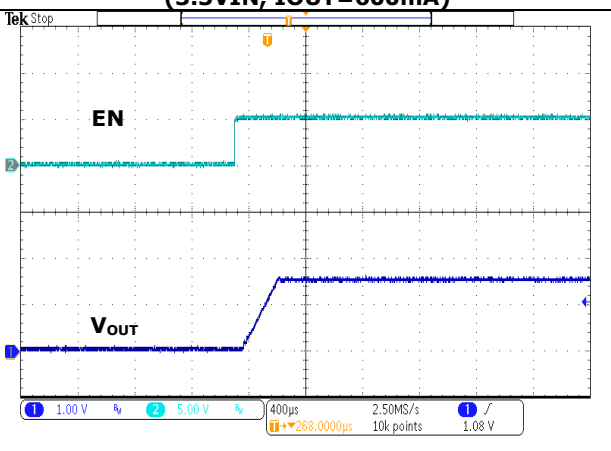
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
■ Output Characteristics						
$V_{OUT(AC)}$	Output ripple voltage	$V_{in} = 3.3\text{V}$, $EN = VIN$ $I_{out} = 0\text{ mA}$				mV
		$V_{out} = 1.5\text{ V}$		17		
		$V_{in} = 3.3\text{V}$, $EN = VIN$ $I_{out} = 600\text{mA}$				mV
		$V_{out} = 1.5\text{ V}$		11		
$C_{OUT(MAX)}$	Maximum capacitive load	$I_{out} = 600\text{mA}$, $ESR \geq 1\text{ m}\Omega$			22	μF
■ Control Characteristics						
V_{REF}	Reference voltage		0.588	0.600	0.612	V
F_{OSC}	Oscillator frequency	PWM Operation	1.2	1.5	1.8	MHz
V_{EN_TH}	Enable rising threshold voltage		1.2	-	-	V
	Enable falling threshold voltage		-	-	0.4	V
■ Fault Protection						
V_{UVLO_TH}	Input under voltage lockout threshold	Falling	-	1.8	-	V
T_{OTP}	Over temp protection		-	160	-	$^{\circ}\text{C}$
I_{LIMIT_TH}	Current limit threshold	Peak value of inductor current,	-	1.5	2.3	A

PIN CONFIGURATION:

PIN DESCRIPTION:

Symbol	Pin No.	Description
VIN	1	Power input pin. It needs to be connected to input rail with input capacitor. A 4.7uF capacitor at least for input.
EN	2	On/Off control pin for module. EN = LOW, the module is off. EN = HIGH, the module is on.
VOUT	3	Power output pin. Connect to output for the load with output capacitor. A 10uF capacitor at least for output.
GND	4	Power ground pin for signal, input, and output return path. This pin needs to be connected to one or more ground plane directly. Connect to thermal exposed pad of GND for heat transferring.

TYPICAL PERFORMANCE CHARACTERISTICS: (1.5V_{OUT})

Conditions: $T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise specified. Test Board Information: 30mm×30mm×1.6mm, 2 layers. The output ripple and transient response are measured by short loop probing and limited to 20MHz bandwidth. The following figures are the typical characteristic curves at 1.5V_{OUT}.


FIGURE 3 EFFICIENCY V.S. LOAD CURRENT

FIGURE 4 DE-RATING CURVE AT 3.3VIN

**FIGURE 5 OUTPUT RIPPLE
(3.3VIN, I_{OUT}=0A)**

**FIGURE 6 OUTPUT RIPPLE
(3.3VIN, I_{OUT}=600mA)**

**FIGURE 7 TRANSIENT RESPONSE
(3.3VIN, 50% to 100% LOAD STEP)**

**FIGURE 8 TURN-ON
(3.3VIN, I_{OUT}=600mA)**

APPLICATIONS INFORMATION:

REFERENCE CIRCUIT FOR GENERAL APPLICATION:

The Figure 9 shows the module application schematics for input voltage +5V or +3.3V and turn on by input voltage directly through enable resistor (Ren).

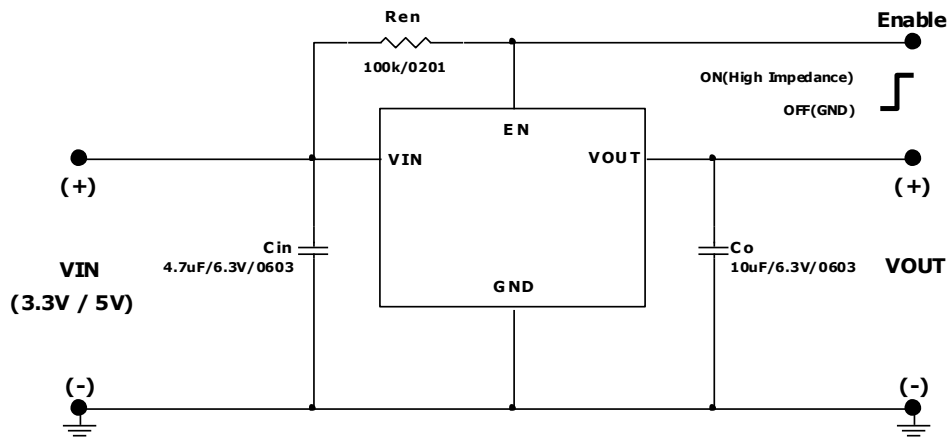


FIGURE 9 GENERAL APPLICATION CIRCUIT WITH TURN-ON BY INPUT VOLTAGE

APPLICATIONS INFORMATION: (Cont.)

SAFETY CONSIDERATIONS:

Certain applications and/or safety agencies may require fuses at the inputs of power conversion components. Fuses should also be used when there is the possibility of sustained input voltage reversal which is not current limited. For greatest safety, we recommend a fast blow fuse installed in the ungrounded input supply line. The installer must observe all relevant safety standards and regulations. For safety agency approvals, install the converter in compliance with the end-user safety standard.

INPUT FILTERING:

The module should be connected to a source supply of low AC impedance and high inductance in which line inductance can affect the module stability. An input capacitor must be placed as near as possible to the input pin of the module so to minimize input ripple voltage and ensure module stability.

OUTPUT FILTERING:

To reduce output ripple and improve the dynamic response as the step load changes, an additional capacitor at the output must be connected. Low ESR polymer and ceramic capacitors are recommended to improve the output ripple and dynamic response of the module.

APPLICATIONS INFORMATION: (Cont.)**Thermal Considerations:**

All of thermal testing condition is complied with JEDEC EIJ/JESD 51 Standards. Therefore, the test board size is 30mm×30mm×1.6mm with 2 layers. The case temperature of module sensing point is shown as Figure 10. Then $R_{th(j_{choke}-a)}$ is measured with the component mounted on an effective thermal conductivity test board on 0 LFM condition. The MMN3C1ER6-MB modules are designed for using when the case temperature is below 110°C regardless the change of output current, input/output voltage or ambient temperature.

Sensing point (Defined case temperature)

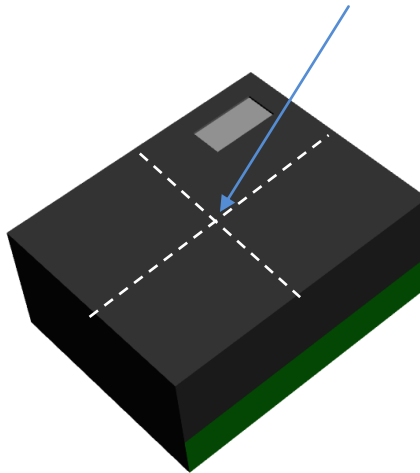
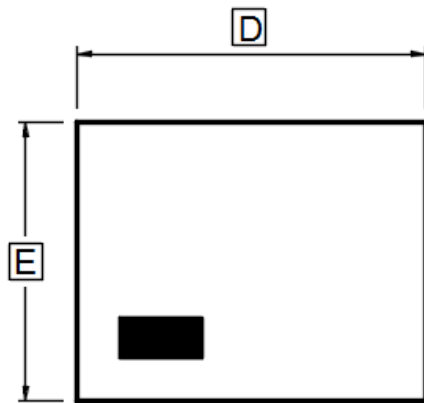


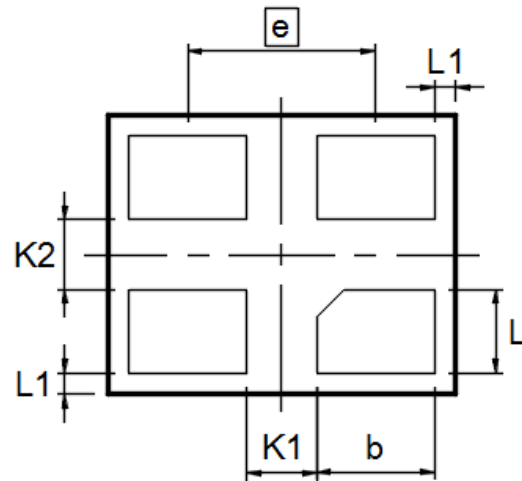
Figure 10 Case Temperature Sensing Point

PACKAGE OUTLINE DRAWING:

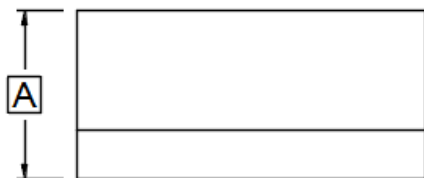
Unit: mm



TOP VIEW



BOTTOM VIEW

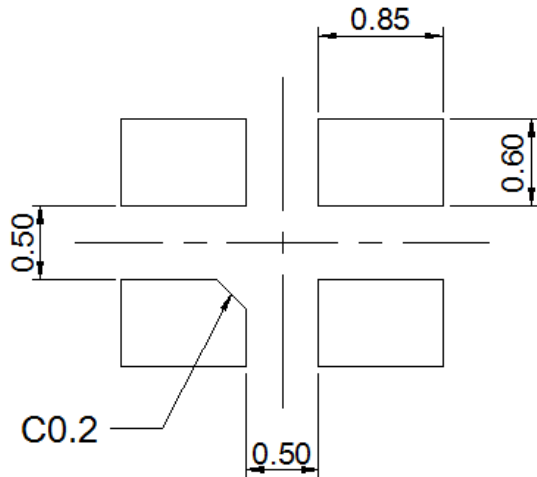


SIDE VIEW

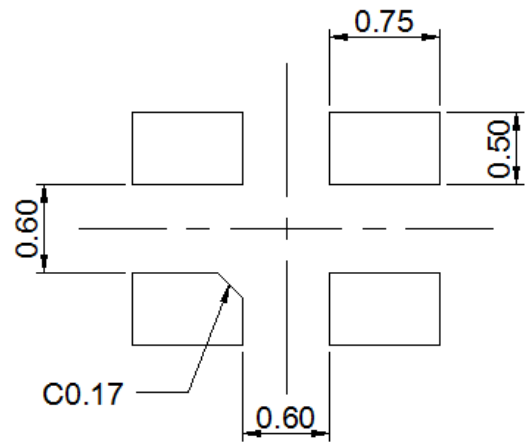
DIM	MILLIMETERS		
	MIN	NOM	MAX
A	-	-	1.05
b	0.75	0.85	0.95
D	2.30	2.50	2.70
E	1.80	2.00	2.20
e	1.25	1.35	1.45
K1	0.40	0.50	0.60
K2	0.40	0.50	0.60
L	0.50	0.60	0.70
L1	0.00	0.15	0.30

LAND PATTERN REFERENCE:

Unit: mm

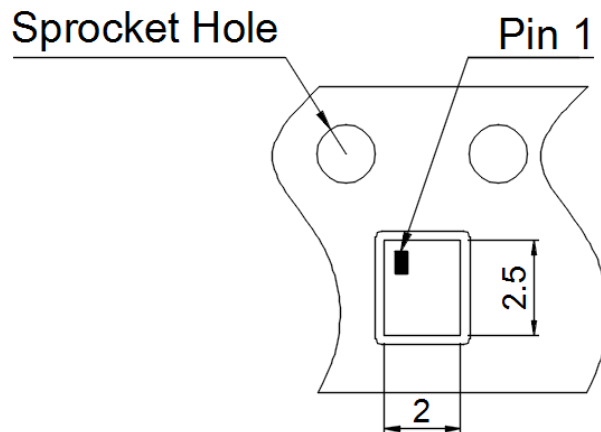
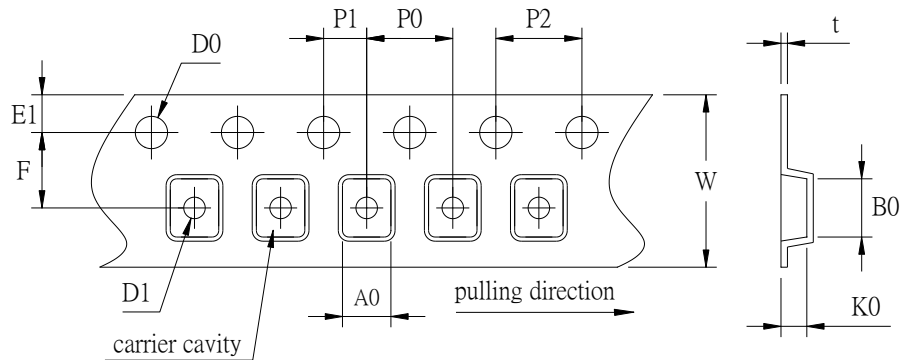


RECOMMENDED LAND PATTERN


RECOMMENDED STENCIL PATTERN
BASED ON 100µm THICKNESS STENCIL

PACKING REFERENCE:

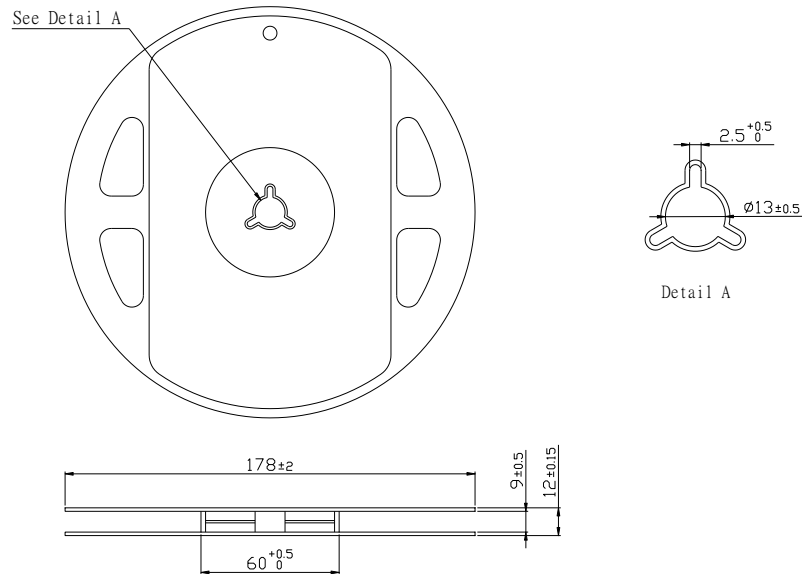
Unit: mm

Package In Tape Loading Orientation

Tape Dimension


A0	2.32 ± 0.10	E1	1.75 ± 0.10
B0	2.82 ± 0.10	K0	1.35 ± 0.10
F	3.50 ± 0.05	P0	4.00 ± 0.10
W	$8.00 +0.30/-0.10$	P1	2.00 ± 0.05
D0	$\phi 1.50 +0.1/-0.0$	P2	4.00 ± 0.10
D1	$\phi 1.0 \text{ Min.}$	t	0.25 ± 0.05

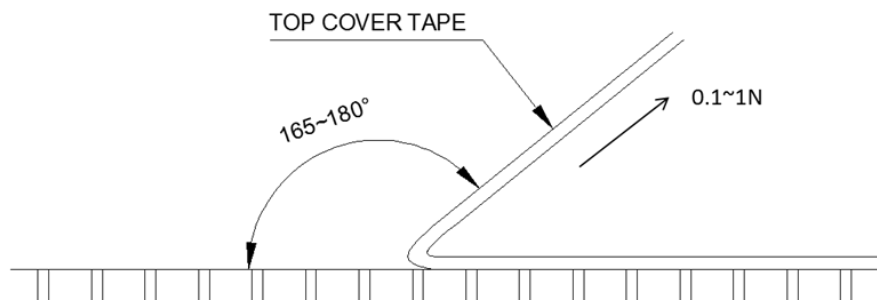
PACKING REFERENCE: (Cont.)

Unit: mm

Reel Dimension

Peel Strength of Top Cover Tape

The peel speed shall be about 300mm/min.

The peel force of top cover tape shall between 0.1N to 1.0N



REVERSION HISTORY:

Date	Revision	Changes